

SACT2018 第 5 回東南アジア熱電会議目前のリマインド

国際交流委員会委員長
森 孝雄

第 5 回東南アジア熱電会議 (SACT2018) が今週末と迫っておりますが、ご参加はまだ歓迎ですので、温かい気候に移動して、日中韓を加えた東南アジアにおける最新の熱電研究の情報収集と議論、交流にどうぞ奮ってご参加下さい。

国際会議名 : 5th Southeast Asia Conference on Thermoelectrics (SACT2018)

日時 : 2018 年 12 月 14 日～12 月 17 日

場所 : Empress Angkor Resort & Spa, Siem Reap, Cambodia

ホームページ :

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Posted on: June 26, 2017

Many TMS2018 presenters will travel to Phoenix, Arizona, from other countries to attend TMS2018. Those presenters who require a travel visa to enter the United States are encouraged to [request a visa invitation letter](#) now and to begin the process of applying for a travel visa today.

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Alloys and Compounds for Thermoelectric and Solar Cell Applications VI

2018 TMS Annual Meeting at Phoenix, Arizona
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This symposium addresses synthesis, property measurements, phase stability, phase transformation of the alloys and compounds used in the thermoelectric and solar cell devices. Materials of interests include, but not limited to, skutterudites, superlattice, half-heusler alloys, CdTe, CIS, CIGS, CZTS and new materials for thermoelectric and solar cell applications. Abstracts are due by July 1st, 2017. Please submit abstracts directly to TMS Online.

(<http://www.tms.org/tms2018>)

(<http://www.programmaster.org/PM/PM.nsf/UpcomingSymposia/279949F4174B7190852580DD000131A2?OpenDocument&ParentUNID=5565C1172B38125085257DCD006DA70B>).

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